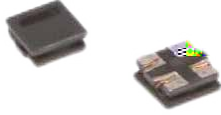


# SCM Series

## SMD Common Mode Inductor

### Size 4015



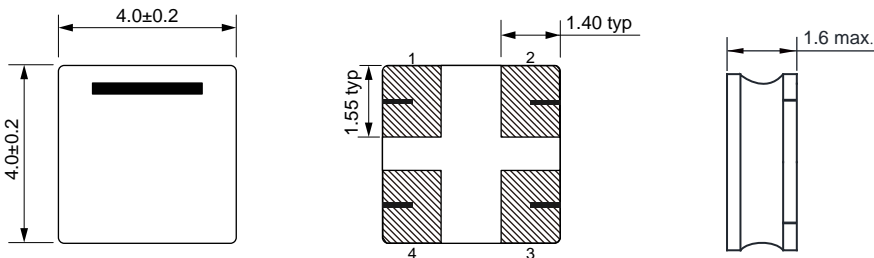
#### FEATURES

- Chip common mode filter for large current applications.
- Low profile design makes it optimal for surface mounting.
- Operating temperature -40~+125 °C.
- Quantity:2500pcs.

#### APPLICATIONS

- Countermeasure of Common mode noise in power lines for various devices.

Dimensions: [mm]



Schematic:



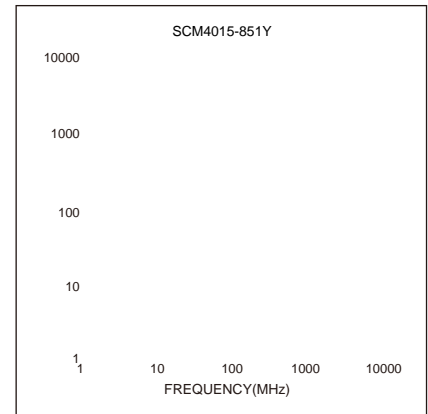
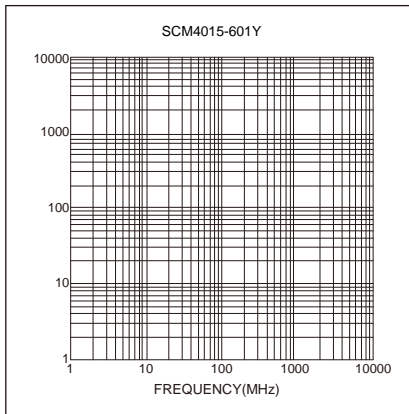
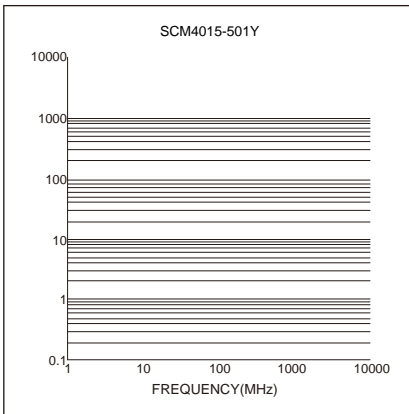
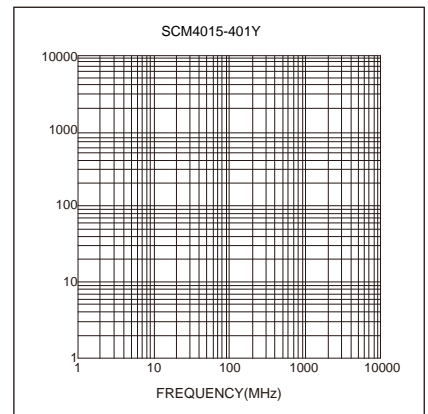
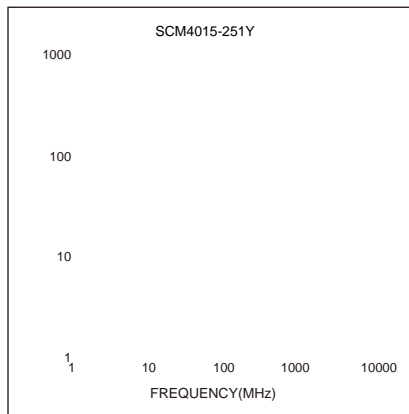
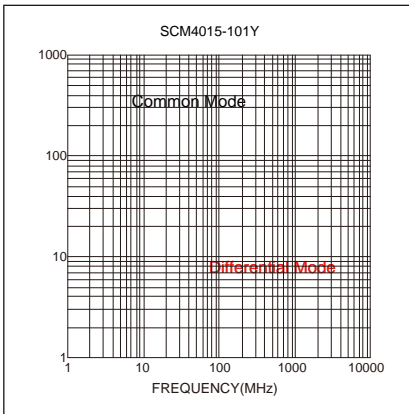
Electrical Properties:

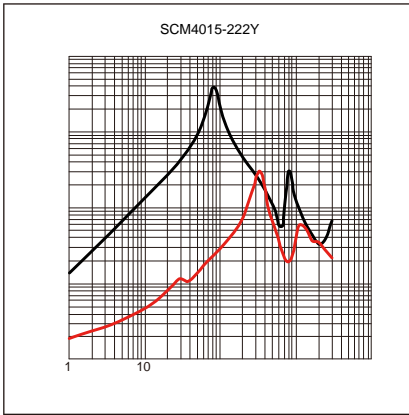
	(Ω)	(Ω)	(Ω)			(MΩ)	

	( $\Omega$ )	( $\Omega$ )	(m $\Omega$ )			(M $\Omega$ )	

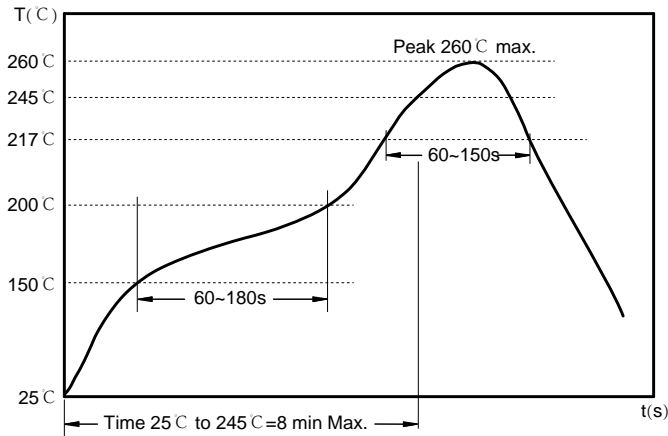
Rated Current: The actual value of DC current when the temperature rise is  $\Delta T=40^{\circ}\text{C}$

### Typical Electrical Characteristics:





## Soldering Reflow:



Preheat condition: 150 ~200 °C / 60~180 sec.

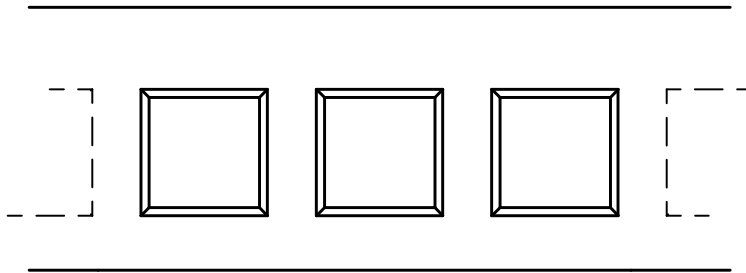
Allowed time above 217 °C: 60~150 sec.

Max temperature: 260 °C.

Max time at max temperature: 10 sec.

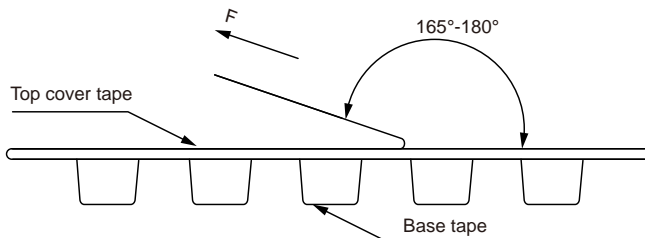
## Packaging Information:

### Tape Dimension :



Series	A0 (mm)	B0 (mm)	D (mm)	P0 (mm)	P1 (mm)	W (mm)	K0 (mm)	E (mm)	T (mm)
SCM4015	4.25±0.1	4.25±0.1	1.5±0.1	4.0±0.2	8.0±0.1	12.0±0.3	1.65±0.1	1.75±0.1	0.25±0.05

### Peel force of top cover tape:

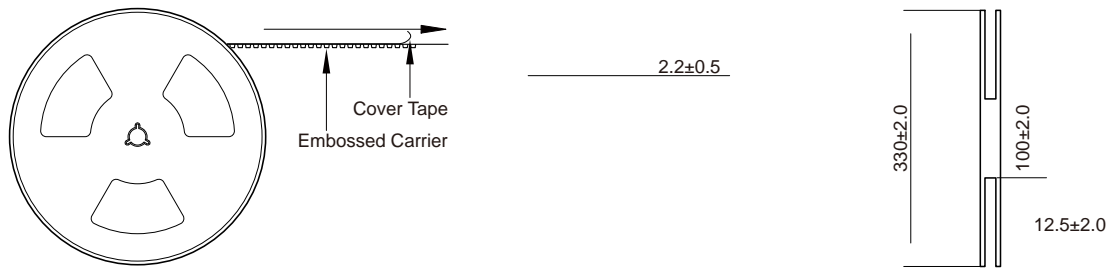


The peel force of top cover tape shall be between 0.1 to 1.17 N

### Product Marking:

Marking	Black bars
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## Reel Dimension : [mm]



## Packaging Quantity:

## Cautions and Warnings:

### Storage Conditions :

- The storage period is within 12 months after the completion of production. Be sure to follow the storage conditions (temperature:  $-5$  to  $35^{\circ}\text{C}$ , humidity: 75% RH Max). If the storage period elapses, the soldering of the terminal electrodes may deteriorate.
- Product should not be exposed to environment with high temperature, high humidity, dust, corrosive gas and etc.
- Products should be handled with care to avoid damage or contamination from perspiration and skin oils.
- Please always handle products carefully to prevent any damage caused by dropping down or inappropriate removing.

### Operation Instructions:

- Self heating (temperature increase) occurs when the power is turned ON, so the tolerance should be sufficient for the set thermal design.
- Before soldering, be sure to preheat components. The preheating temperature should be set so that the temperature difference between the solder temperature and chip temperature does not exceed  $150^{\circ}\text{C}$ .
- Soldering corrections after mounting should be within the range of the conditions determined in the specifications. If overheated, a short circuit, performance deterioration, or lifespan shortening may occur.
- Generally, Koher might not be familiar with either customer's specific application or actual requests as customer does. As a result customer shall be responsible for checking and confirming whether Koher product with the performance described in the product specification is suitable for using in customer's particular application or not.